

1. Table of Contents (This Page)

Created on Tue Jul 15 13:43:00 2014

2. component

3. signal

4. ground

5. backside

6. outline

7. grounds

8. power

9. plated-drill

10. componentmask

11. soldermask

12. topsilk

13. bottomsilk

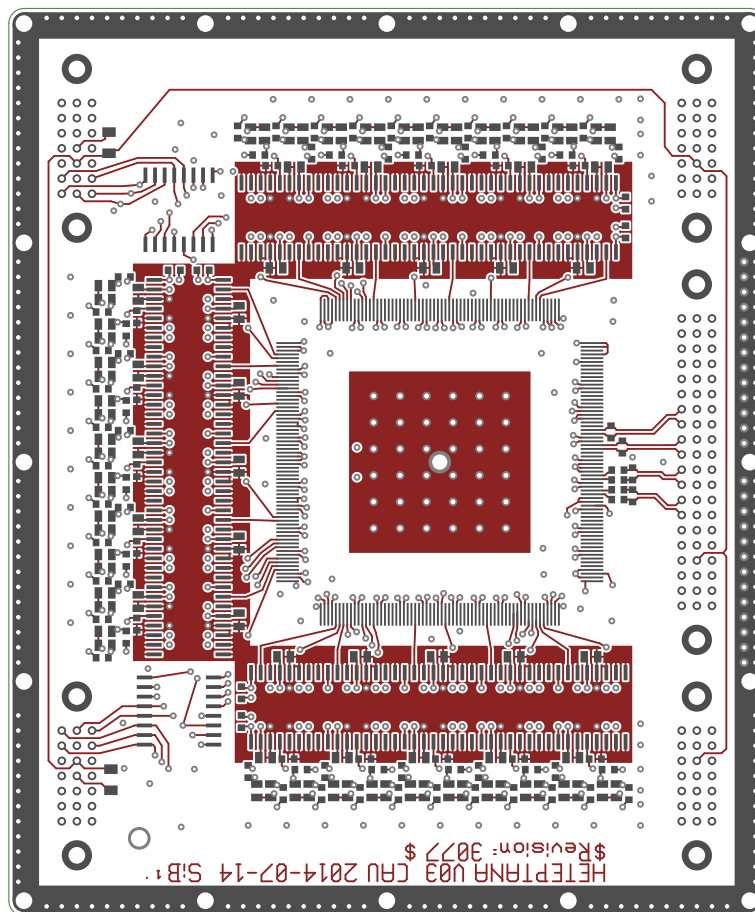
14. toppaste

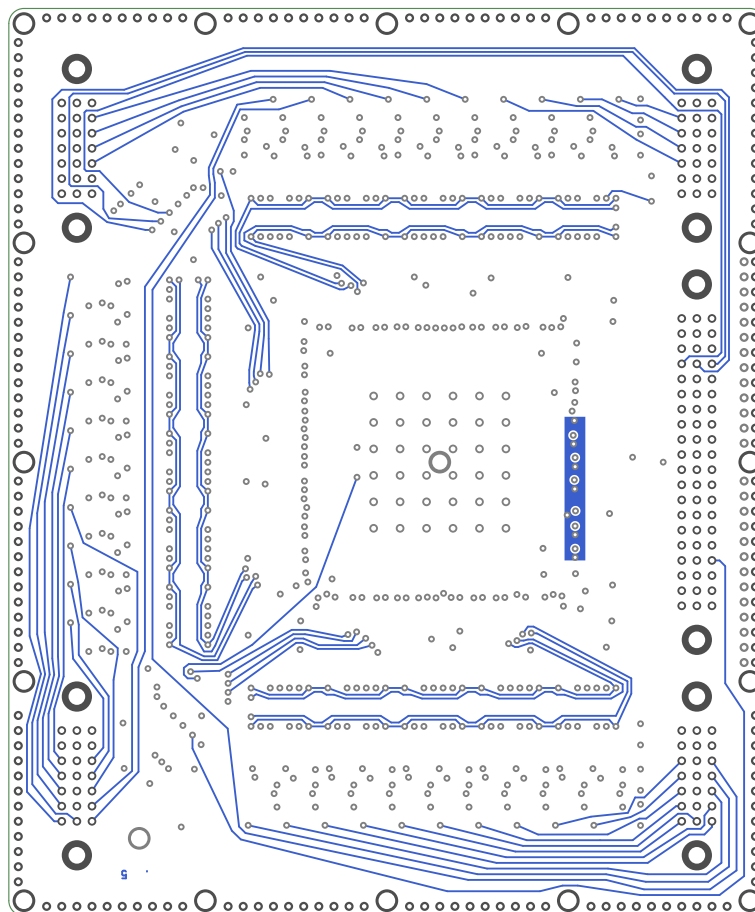
15. bottompaste

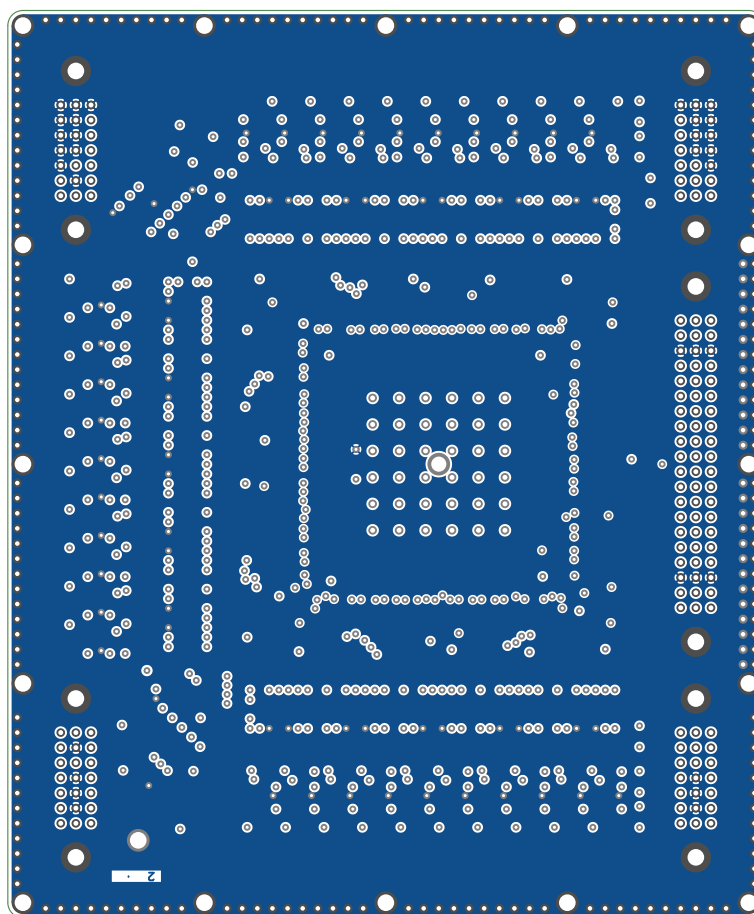
16. topassembly

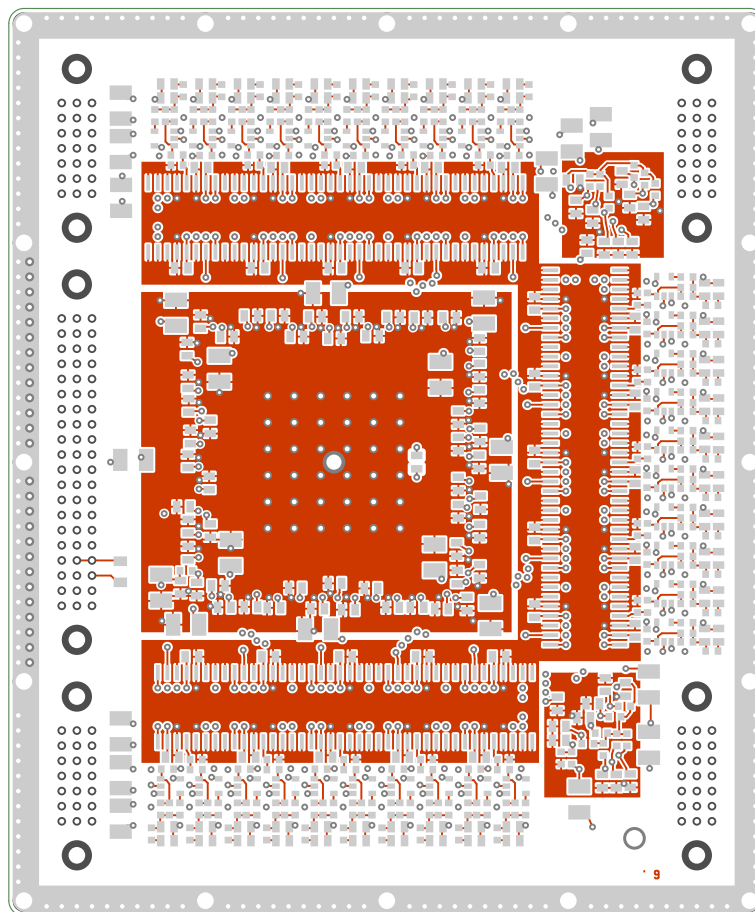
../heptana-actel.pcb
17. bottomassembly

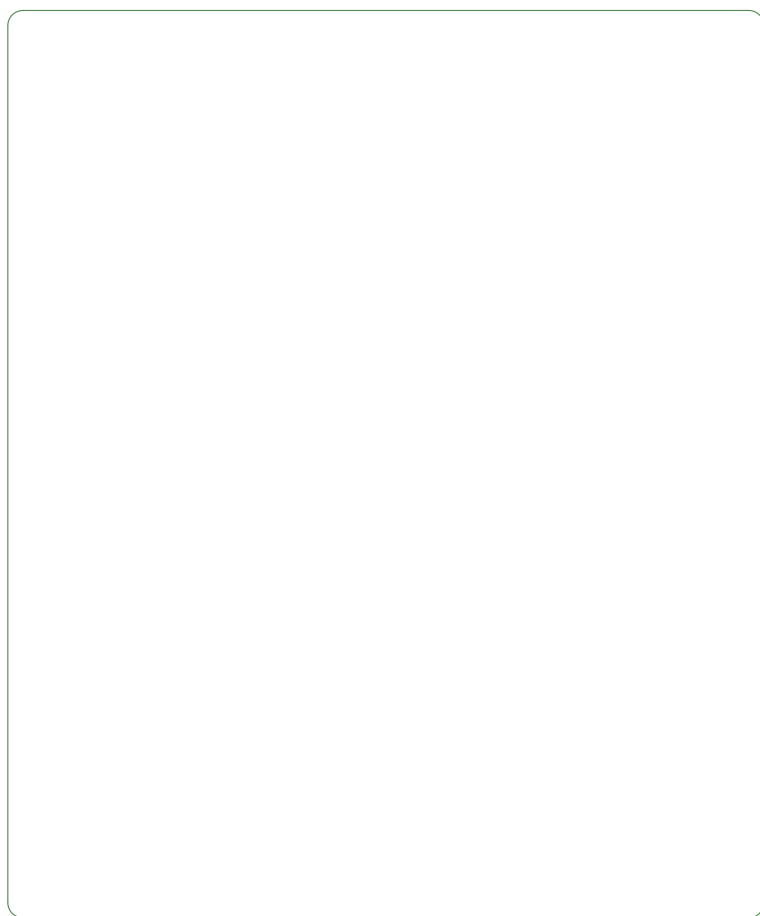
18. f.l

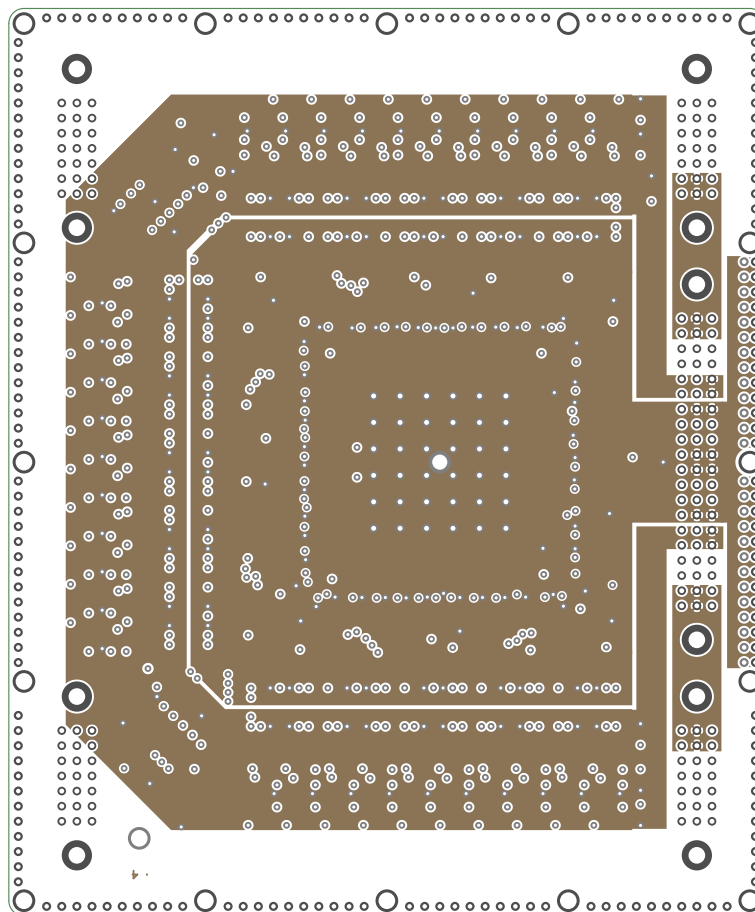


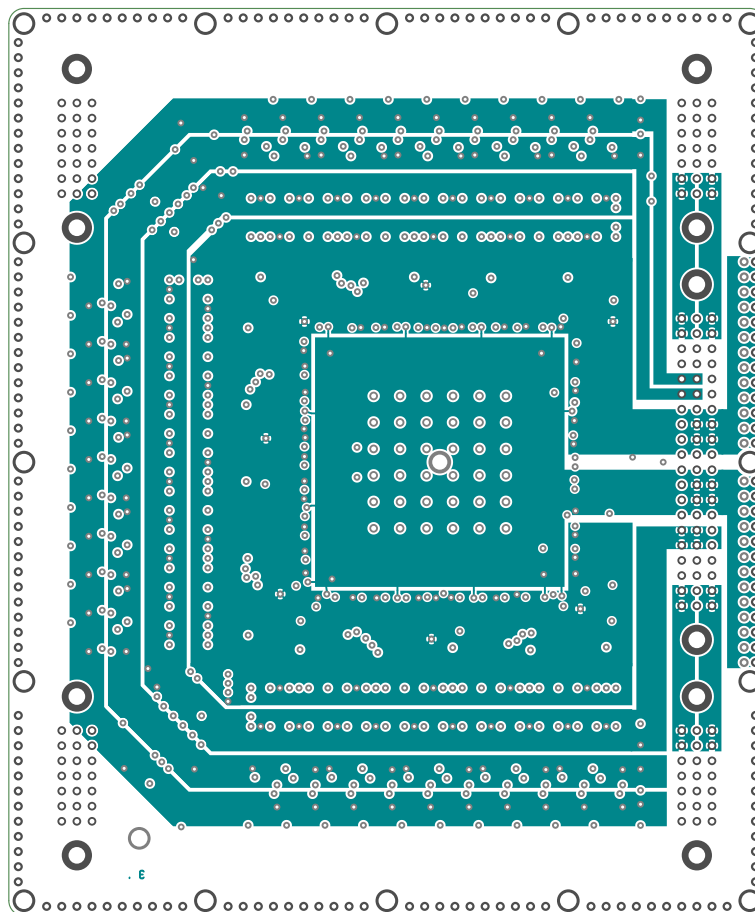


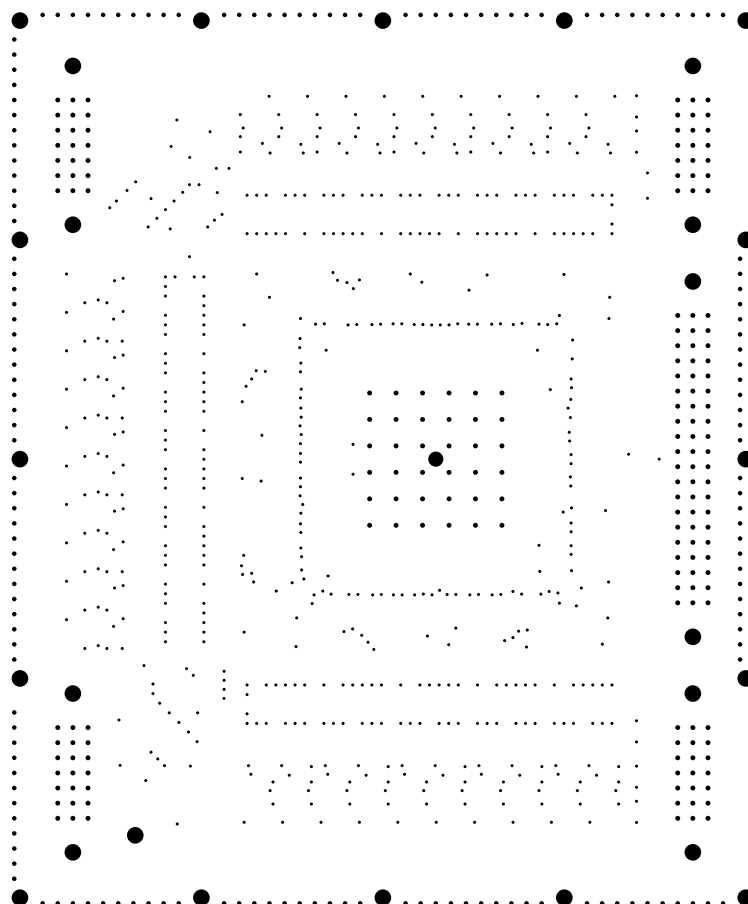


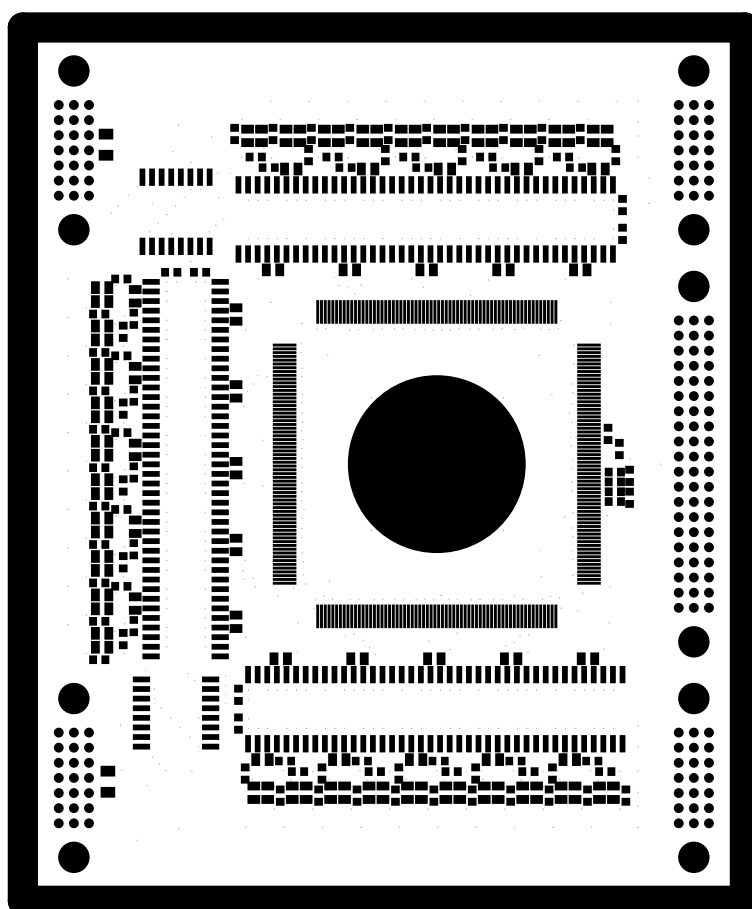


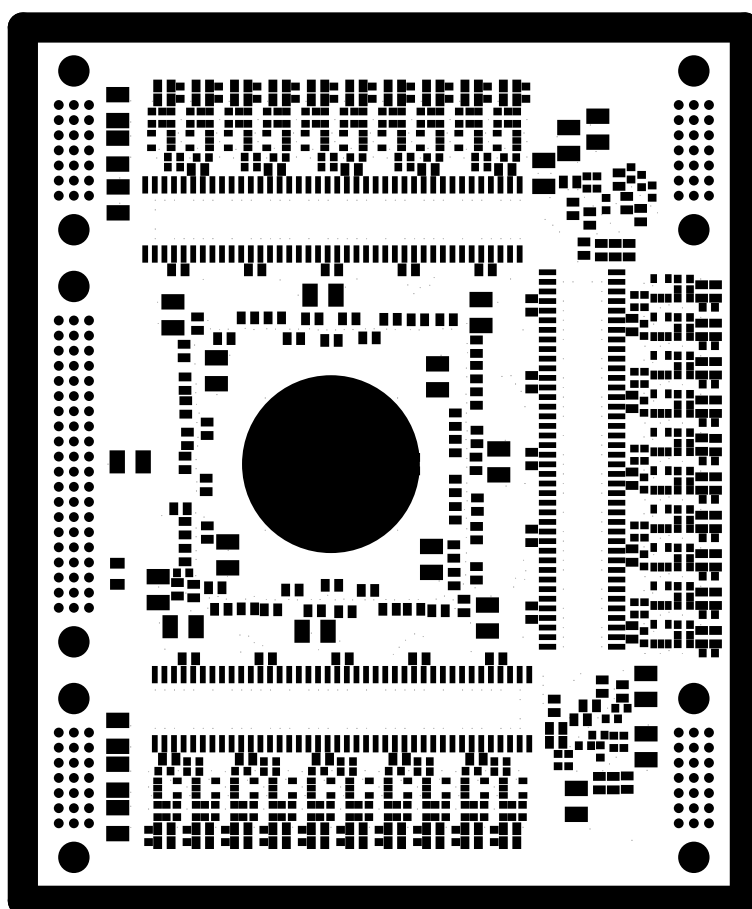


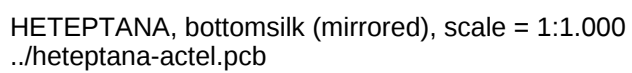


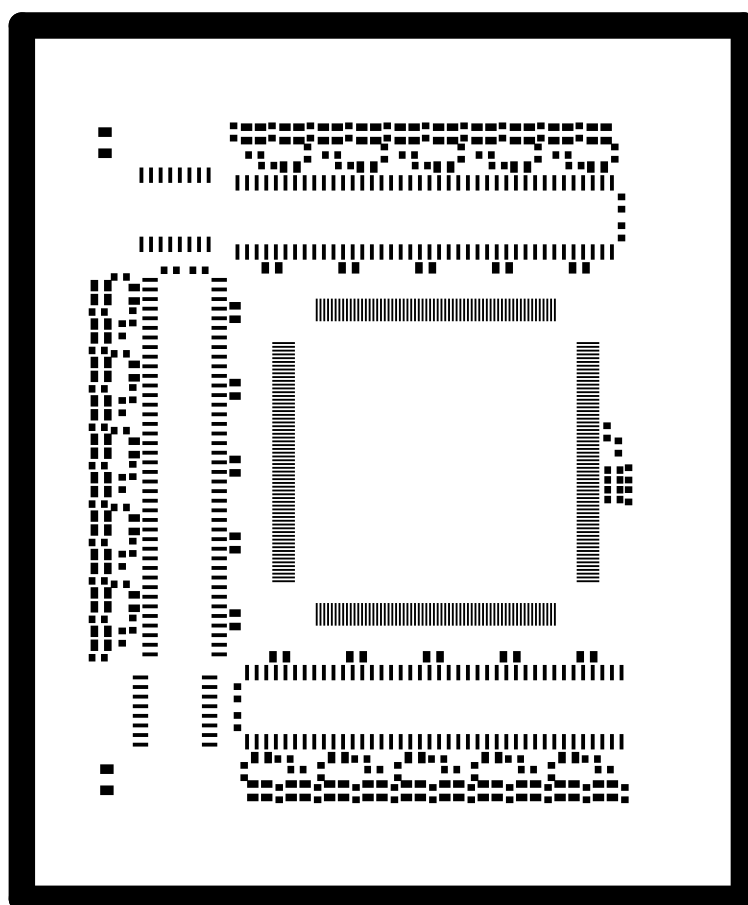


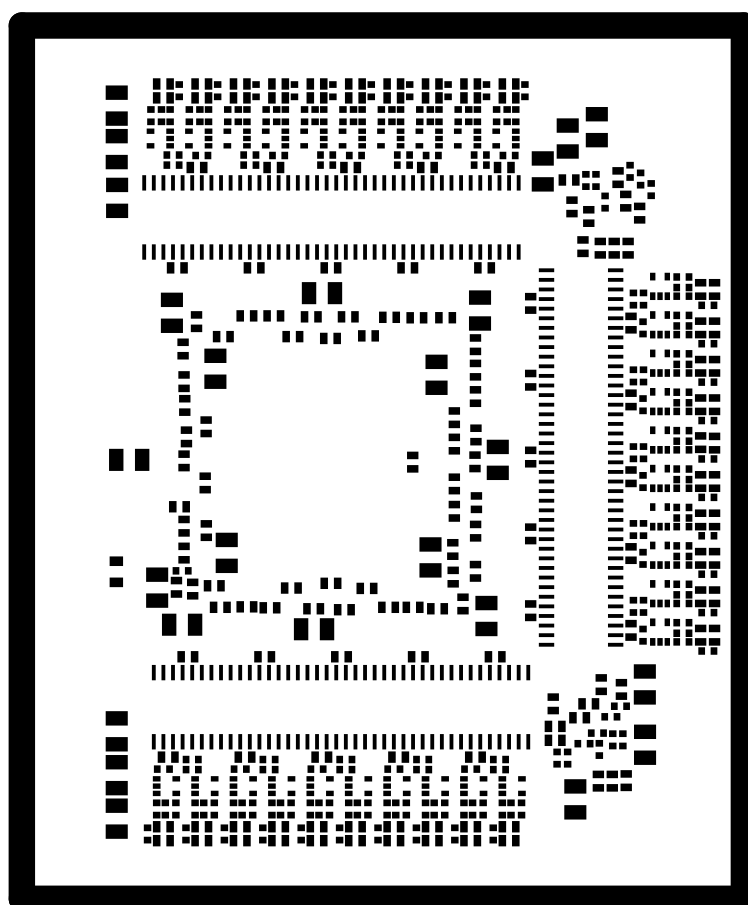


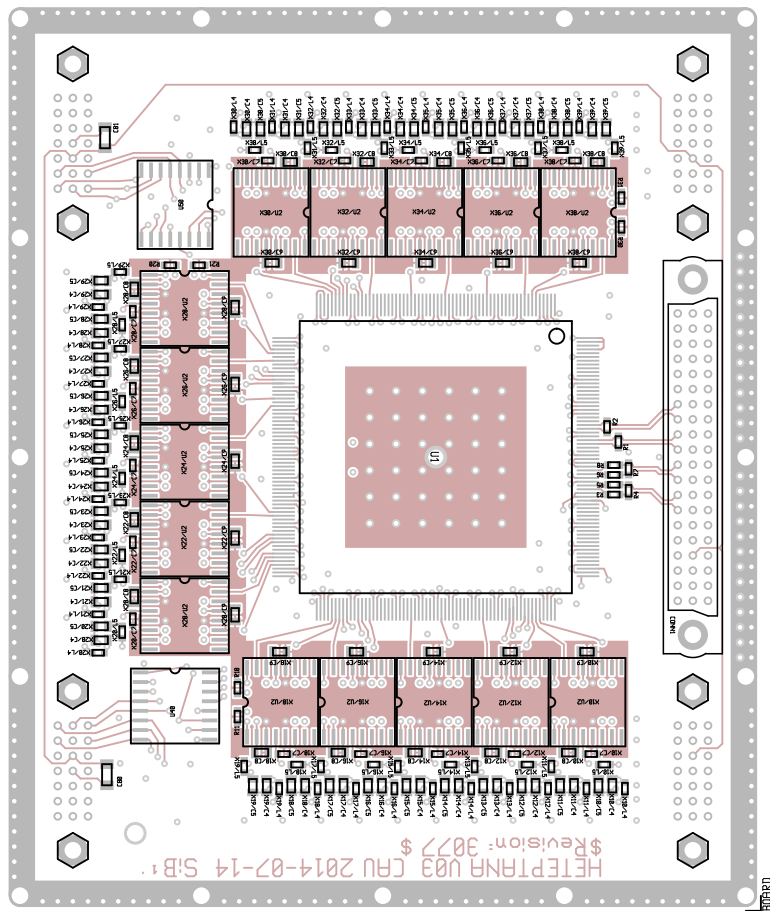


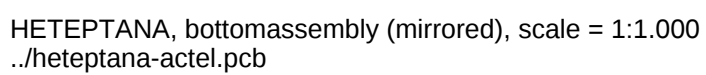












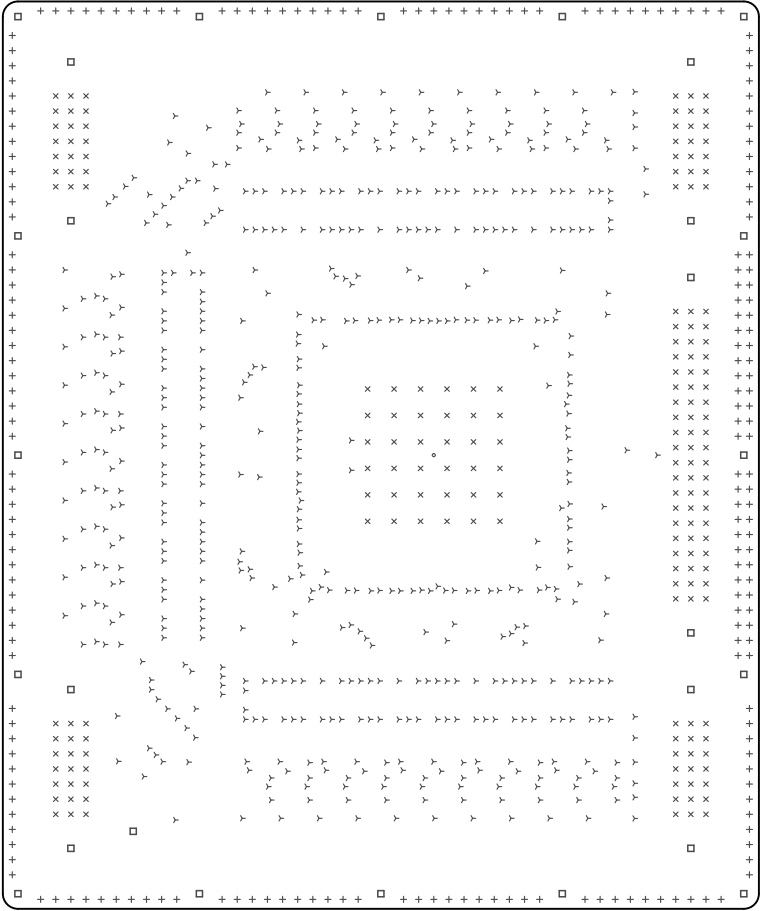
There are 5 different drill sizes used in this layout, 1013 holes total

Symbol	Diam. (Inch)	Count	Plated?
y	0.016	597	YES
+	0.024	208	YES
x	0.026	180	YES
.	0.029	1	YES
□	0.087	27	YES

Title: HETEPTANA - Fabrication Drawing

Author: Stephan Boettcher

Date: Di 15 Jul 2014 11:43:01 GMT UTC



Board outline is the centerline of this path